



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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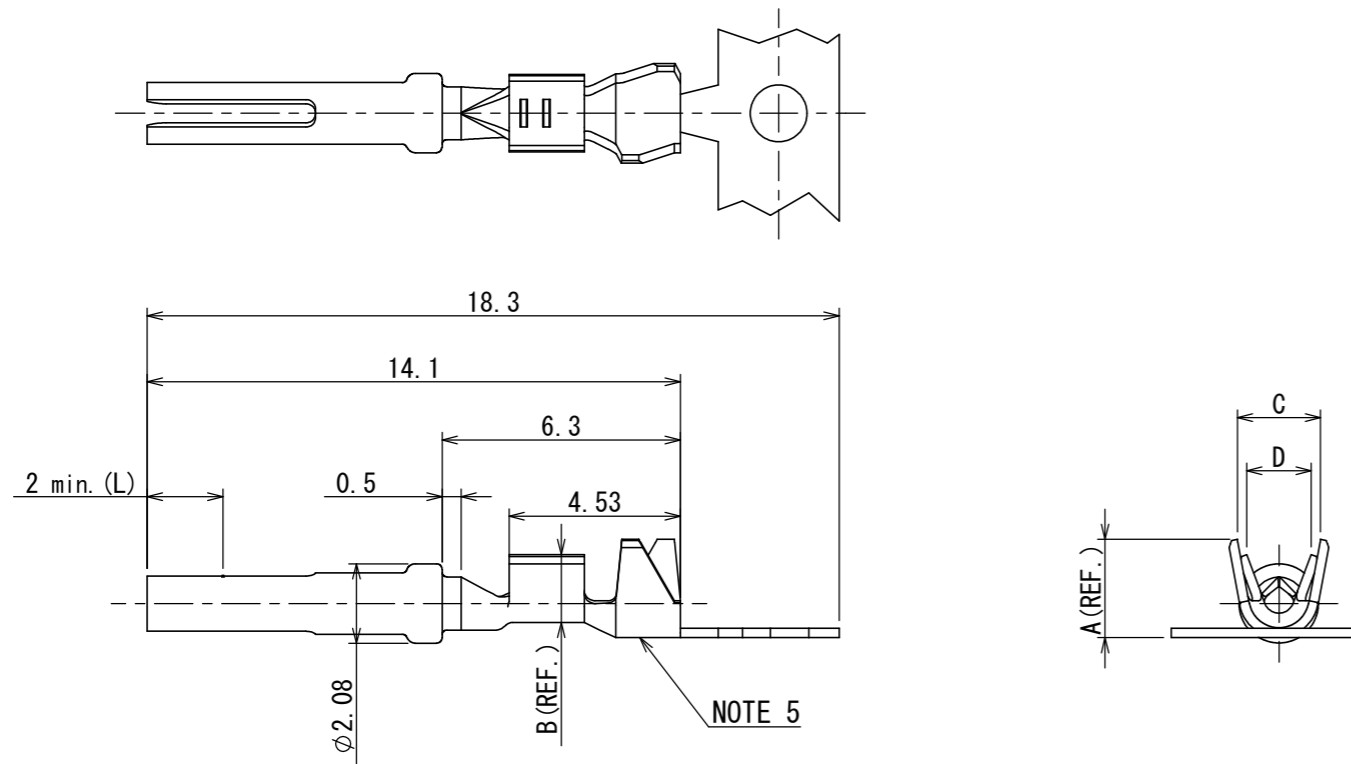
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SJ017240
(DRAWING NO.)

版数 VER.	年月日 DATE	CN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
10	12/NOV/2010	071025	Japanese-Bilingual ラベル貼り付け位置変更 其他	M. SHINOZAKI	K. KUGOU	O. TAKAGI	Y. OOTSUKA
11	04/MAR/2013	005585	誤記訂正		K. KUGOU	O. TAKAGI	T. MIYASHITA



- NOTE 1. CONTACTS ARE SUPPLIED IN REELED FROM WITH 10000 CONTACTD PER REEL.
 2. MARK TRADE PART No. AND No. OF CONTACTS.
 3. CRIMP TOOL
 TYPE: CT350-2C-D*C (D*C SEMI AUTOMATICH CRIMPING MACHINE AWG#22~#28)
 CT350-2-D*C30 (D*C SEMI AUTOMATICH CRIMPING MACHINE AWG#28~#30)
 4. CONTACT FILNISH

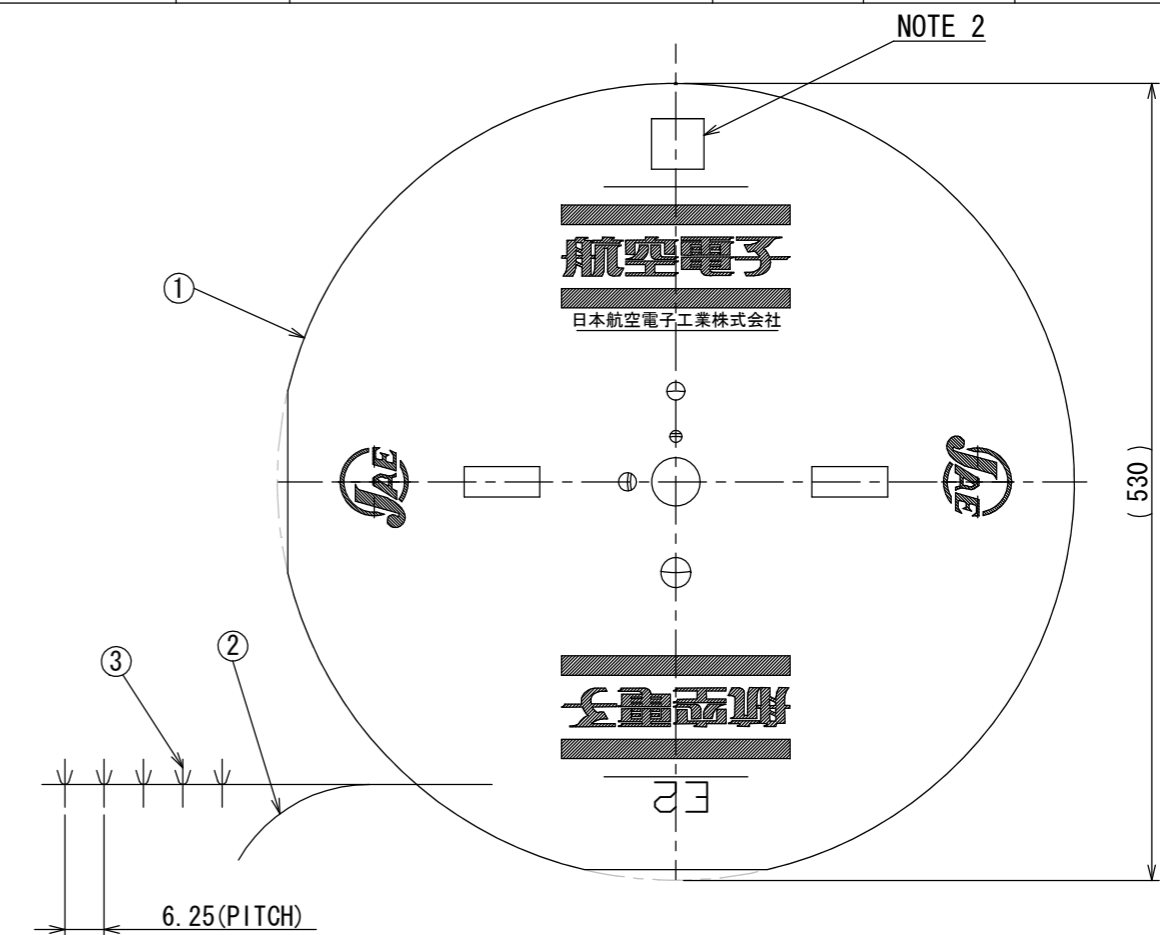
IN THE L DIMENSION	GOLD OVER NICKEL (AU 0.1 μM MIN, NI 1.50.1 μM MIN)
OTHER AREA	GOLD FLASH PLATING OVER NICKEL (GOLD FLASH, NI 1.5 μM MIN)

5. APPLICABLE WIRE IDENTIFICATION ARE MARKED AS INDICATED.
 6. EXTRACTION TOOL JIET-D*C-20 OR ET-20D IS USED.

PART NO.	D*C-20-22S-10000 Δ		D*C-20-24S-10000 Δ	
	AWG#22~24 (INSULATION DIA ϕ 1.2~1.7)	AWG#24~28 (INSULATION DIA ϕ 0.8~1.5)	AWG#30 (INSULATION DIA ϕ 0.5~1.2)	
A	2.6		2.3	
B	1.8		1.55	
C	2.2		1.8	
D	1.7		1.5	
INDETIFICATION MARK (NOTE 5)	22		24	

- 注1. 本コンタクトは、リール状で供給され、10000本/リールとする。
 2. 図示の位置に品名及び数量を記入した、ラベルが貼られている。
 3. 下記の半自動圧着機に装着する。
 型式: CT350-2C-D*C (D*C半自動圧着機AWG#22~#28圧着用)
 CT350-2-D*C30 (D*C半自動圧着機AWG#28~#30圧着用)
 4. コンタクト仕上

L寸法内	Ni上Auメッキ (Ni 1.5 μm以上、Au 0.1 μm以上)
その他	Ni上Auフラッシュ (Ni 1.5 μm以上 Auフラッシュ)



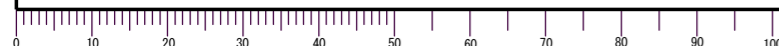
5. 図示の位置に適用電線識別マークが表示される。
 6. 引抜工具はJIET-D*C-20又は、ET-20Dを使用する。

品名	D*C-20-22S-10000 Δ		D*C-20-24S-10000 Δ	
	AWG#22~24 (仕上外径 ϕ 1.2~1.7)	AWG#24~28 (仕上外径 ϕ 0.8~1.5)	AWG#30 (仕上外径 ϕ 0.5~1.2)	
A	2.6		2.3	
B	1.8		1.55	
C	2.2		1.8	
D	1.7		1.5	
識別マーク (注5)	22		24	

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
3	SOCKET CONTACT	10000	COPPER ALLOY		NOTE 4
2	TAPE	1	PAPER		
1	MAGAZINE	1	PAPER		

仕様書 (SPECIFICATION)	第1版 (ORIGINAL DATE) 17/DEC/1981	尺度 (SCALE)	シリーズ (SERIES) Dsub	日本航空電子工業株式会社
一般公差 (GENERAL TOLERANCE)	製図 DR. K. KATOU	名称 (TITLE)		JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.
寸法 (DIMENSION)	担当 CHK. O. TAKAGI	D*C-20-22S-10000 D*C-20-24S-10000		
角度 (ANGLES)	査閲 APPD. Y. TAKEUCHI			
±0.8	承認 APPD. S. HASHIMOTO			
× ±0.4				
×× ±0.1				
××× ±				
単位 (UNIT) : mm		質量 (MASS)		図面番号 (DRAWING NO.) SJ017240

DCF-C-212H(12.08)



S/W

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